SQ2310CES

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Vishay Siliconix

Automotive N-Channel 20 V (D-S) 175 °C MOSFET



FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

N-Channel MOSFET



RoHS COMPLIANT HALOGEN FREE

Marking Code: 9PYXX

PRODUCT SUMMARY				
V _{DS} (V)	20			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.030			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 2.5 V$	0.034			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 1.8 V$	0.038			
I _D (A)	6			
Configuration	Single			

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	SQ2310CES (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	20	N	
Gate-source voltage		V _{GS} ± 8		- V	
Continuous drain current	T _C = 25 °C	1	6		
	T _C = 125 °C	I _D	3.5		
Continuous source current (diode conduction)		I _S	2.5	А	
Pulsed drain current ^a		I _{DM}	24		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	10		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	5	mJ	
Maximum power dissipation	T _C = 25 °C	PD	2	W	
	T _C = 125 °C	۳D	0.6	vv	
Operating junction and storage temperature	range	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	175	°C/W	
Junction-to-foot (drain)		R _{thJF}	75	0/11	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR-4 material)

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•	•	•	•
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		20	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		0.4	0.6	1	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 20 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 20 V, T _J = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V _{DS} = 20 V, T _J = 175 °C	-	-	150	
On-state drain current ^a	I _{D(on)}	$V_{GS} = 4.5 V$	$V_{DS} \ge 5 V$	10	-	-	Α
		V _{GS} = 4.5 V	I _D = 5 A	-	0.022	0.030	Ω
		V _{GS} = 4.5 V	I _D = 5 A, T _J = 125 °C	-	-	0.043	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5V$	I _D = 5 A, T _J = 175 °C	-	-	0.051	
	. ,	V _{GS} = 2.5 V	I _D = 4 A	-	0.025	0.034	
		V _{GS} = 1.8 V	I _D = 3.6 A	-	0.029	0.038	
Forward transconductance b	g _{fs}	V _{DS} = 15 V, I _D = 4 A		-	25	-	S
Dynamic ^b		1 -		I	I	1	
Input capacitance	C _{iss}		V _{DS} = 10 V, f = 1 MHz	-	426	590	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	106	140	
Reverse transfer capacitance	C _{rss}			-	52	70	
Total gate charge ^c	Qg			-	4.95	8.5	nC
Gate-source charge ^c	Q _{gs}	V _{GS} = 4.5 V	V _{DS} = 10 V, I _D = 5 A	-	0.65	-	
Gate-drain charge ^c	Q _{gd}	1		-	0.93	-	
Gate resistance	Rg	f = 1 MHz		4	9.4	16	Ω
Turn-on delay time ^c	t _{d(on)}				6	11	
Rise time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 10 \; V, \; R_{\text{L}} = 2.5 \; \Omega \\ I_{\text{D}} \cong 4 \; A, \; V_{\text{GEN}} = 4.5 \; V, \; R_{\text{g}} = 1 \; \Omega \end{array}$		-	19	30	ns
Turn-off delay time ^c	t _{d(off)}			-	29	45	
Fall time ^c	t _f			-	6	10	
Source-Drain Diode Ratings and Character	eristics ^b	•			•		1
Pulsed current ^a	I _{SM}			-	-	24	Α
Forward voltage	V _{SD}	I _F = 2.8 A, V _{GS} = 0 V		-	0.70	1.2	V
Body diode reverse recovery time	t _{rr}	1		-	7	14	ns
Body diode reverse recovery charge	Qrr	I _F = 4 A, di/dt = 100 A / μs		-	2	4	nC
Reverse recovery fall time	t _a			-	7	-	l
Reverse recovery rise time	t _b			-	3	-	ns
Body diode peak reserve recovery current	I _{RM(REC)}			-	-0.6	-	Α

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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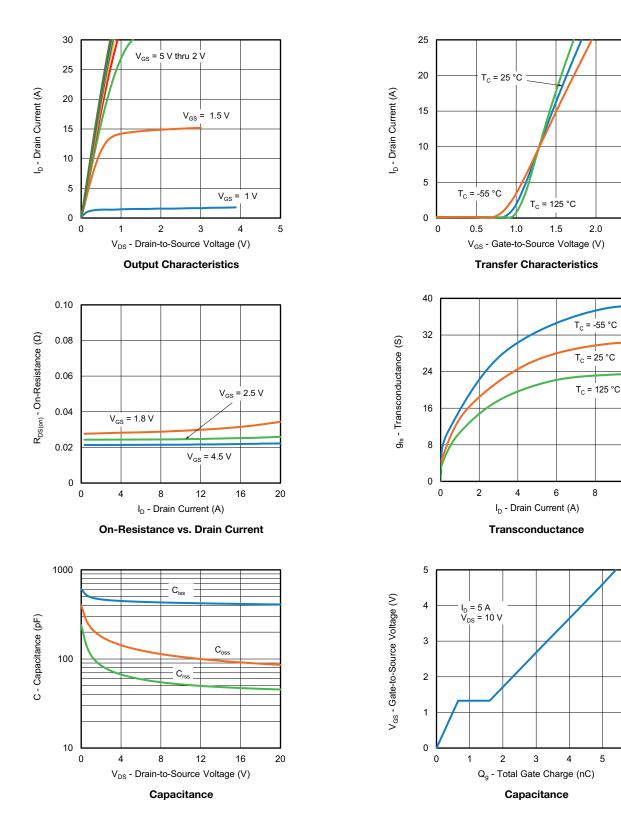


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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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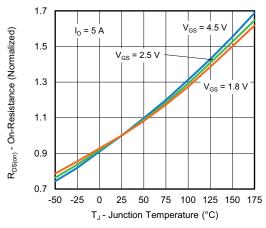
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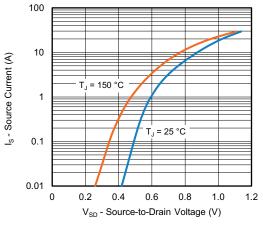
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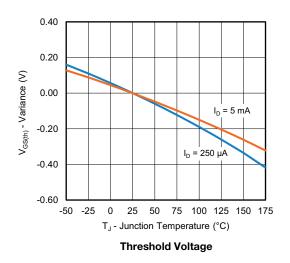
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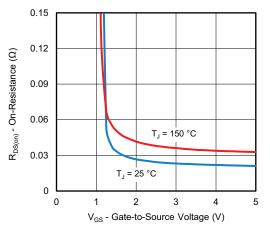


On-Resistance vs. Junction Temperature

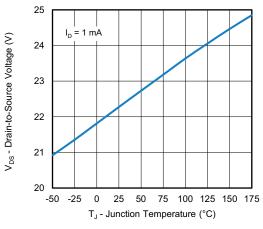


Source Drain Diode Forward Voltage

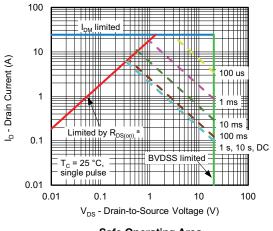




On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



Safe Operating Area

a. V_{GS} > minimum V_{GS} at which $R_{DS(ON)}$ is specified

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Note

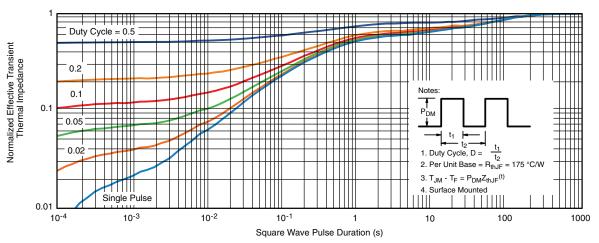
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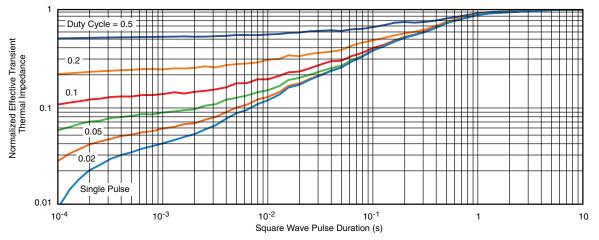


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62145.

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